



## Product Design and Development Using Computational and Numerical Modeling

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Deadline for manuscript submissions:

**closed (15 June 2023)**

### Message from the Guest Editors

This Special Issue aims to share the latest research, theories, and practices in product design and manufacturing technology in order to improve industrial performance. It will focus on how traditional and more sophisticated modeling methods can work together and how virtual manufacturing processes can be a source of new information.

Potential topics include but are not limited to:

- Product design and development for circular business models;
- Design for manufacturable hollow structures, cellular structures, multiscale structures, multimaterial structures, and composite structures;
- Modeling, simulation, and control of manufacturing system;
- Design optimization methods such as topology optimization, size optimization, and shape optimization to support advanced manufacturing;
- Design for heterogeneous materials systems using hybrid manufacturing;
- Sustainable product design and development in small and medium-sized enterprises (SMEs);
- Sustainability in early product design and development;
- Democratization, fairness, inclusion, bias, and ethics in emerging PDD technologies and methods;
- Security, privacy, and intellectual property concerns in PDD.





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## Editor-in-Chief

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## Message from the Editor-in-Chief

*Electronics* is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

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